Preferred Devices

Dual Common Base-Collector Bias Resistor Transistors NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSTB1002DXV5T1G series, two complementary devices are housed in the SOT–553 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- These are Pb–Free Devices

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted, common for Q_1 and Q_2 , – minus sign for Q_1 (PNP) omitted)

		Valu	Value	
Rating	Symbol	Q1	Q2	Unit
Collector-Base Voltage	V _{CBO}	-40	50	Vdc
Collector-Emitter Voltage	V _{CEO}	-40	50	Vdc
Collector Current	Ι _C	-200	100	mAdc

THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D	357 (Note 1) 2.9 (Note 1)	mW mW/°C
Thermal Resistance – Junction-to-Ambient	R_{\thetaJA}	350 (Note 1)	°C/W
Characteristic (Both Junctions Heated)	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D	500 (Note 1) 4.0 (Note 1)	mW mW/°C
Thermal Resistance – Junction-to-Ambient	R_{\thetaJA}	250 (Note 1)	°C/W
Junction and Storage Temperature	T _J , T _{stq}	-55 to +150	°C

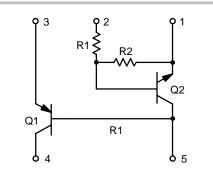
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad



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CASE 463B

MARKING DIAGRAM



U9 = Specific Device Code

- M = Date Code
- = Pb–Free Package
- (Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping
NSTB1002DXV5T1G		4 mm pitch 4000/Tape & Reel
NSTB1002DXV5T5G		2 mm pitch 8000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit

Vdc

Vdc

Vdc

nAdc

nAdc

Q1 TRANSISTOR: PNP **OFF CHARACTERISTICS** Collector-Emitter Breakdown Voltage (Note 2) -40 V_{(BR)CEO} _ Collector-Base Breakdown Voltage -40 V_{(BR)CBO} _ Emitter-Base Breakdown Voltage -5.0 V_{(BR)EBO} _ Base Cutoff Current -50 I_{BL} _ Collector Cutoff Current -50 I_{CEX} _ **ON CHARACTERISTICS** (Note 2) DC Current Gain h_{FE}

$ (I_{C} = -0.1 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_{C} = -1.0 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_{C} = -10 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_{C} = -50 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_{C} = -100 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) \\ (I_{C} = -100 \text{ mAdc}, V_{CE} = -1.0 \text{ Vdc}) $		60 80 100 60 30	- 300 - -		
Collector – Emitter Saturation Voltage $(I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc})$ $(I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc})$	V _{CE(sat)}	-	-0.25 -0.4	Vdc	
Base – Emitter Saturation Voltage $(I_C = -10 \text{ mAdc}, I_B = -1.0 \text{ mAdc})$ $(I_C = -50 \text{ mAdc}, I_B = -5.0 \text{ mAdc})$	V _{BE(sat)}	-0.65 -	-0.85 -0.95	Vdc	

SMALL-SIGNAL CHARACTERISTICS

Current-Gain – Bandwidth Product	f _T	250	-	MHz
Output Capacitance	C _{obo}	-	4.5	pF
Input Capacitance	C _{ibo}	-	10.0	pF
Input Impedance $(V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz})$	h _{ie}	2.0	12	kΩ
Voltage Feedback Ratio $(V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz})$	h _{re}	0.1	10	X 10 ⁻⁴
Small – Signal Current Gain ($V_{CE} = -10 \text{ Vdc}, I_C = -1.0 \text{ mAdc}, f = 1.0 \text{ kHz}$)	h _{fe}	100	400	-
Output Admittance ($V_{CE} = -10$ Vdc, $I_C = -1.0$ mAdc, f = 1.0 kHz)	h _{oe}	3.0	60	μmhos
Noise Figure (V _{CE} = -5.0 Vdc, I _C = $-100 \ \mu$ Adc, R _S = $1.0 \ k\Omega$, f = $1.0 \ kHz$)	nF	-	4.0	dB

SWITCHING CHARACTERISTICS

Delay Time	$(V_{CC} = -3.0 \text{ Vdc}, V_{BE} = 0.5 \text{ Vdc})$	t _d	-	35	20
Rise Time	$(I_{C} = -10 \text{ mAdc}, I_{B1} = -1.0 \text{ mAdc})$	t _r	-	35	ns
Storage Time	$(V_{CC} = -3.0 \text{ Vdc}, I_C = -10 \text{ mAdc})$	t _s	-	225	
Fall Time	(I _{B1} = I _{B2} = -1.0 mAdc)	t _f	-	75	ns

Q2 TRANSISTOR: NPN

OFF CHARACTERISTICS

Collector-Base Cutoff Current ($V_{CB} = 50 \text{ V}, I_E = 0$)	I _{CBO}	-	-	100	nAdc
Collector-Emitter Cutoff Current $(V_{CB} = 50 \text{ V}, I_B = 0)$	I _{CEO}	-	-	500	nAdc
Emitter-Base Cutoff Current ($V_{EB} = 6.0, I_C = 5.0 \text{ mA}$)	I _{EBO}	-	-	0.1	mAdc

2. Pulse Test: Pulse Width \leq 300 $\mu s;$ Duty Cycle \leq 2.0%.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit			
ON CHARACTERISTICS								
Collector-Base Breakdown Voltage ($I_C = 10 \ \mu A, I_E = 0$)	V _{(BR)CBO}	50	-	-	Vdc			
Collector-Emitter Breakdown Voltage $(I_C = 2.0 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	50	-	-	Vdc			
DC Current Gain $(V_{CE} = 10 \text{ V}, I_C = 5.0 \text{ mA})$	h _{FE}	80	140	-				
Collector–Emitter Saturation Voltage $(I_C = 10 \text{ mA}, I_B = 0.3 \text{ mA})$	V _{CE(SAT)}	-	-	0.25	Vdc			
Output Voltage (on) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 2.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V _{OL}	-	-	0.2	Vdc			
Output Voltage (off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.5 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V _{OH}	4.9	-	-	Vdc			
Input Resistor	R1	33	47	61	kΩ			
Resistor Ratio	R1/R2	0.8	1.0	1.2				

2. Pulse Test: Pulse Width \leq 300 µs; Duty Cycle \leq 2.0%.

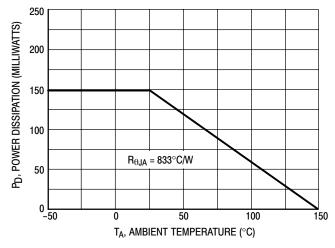
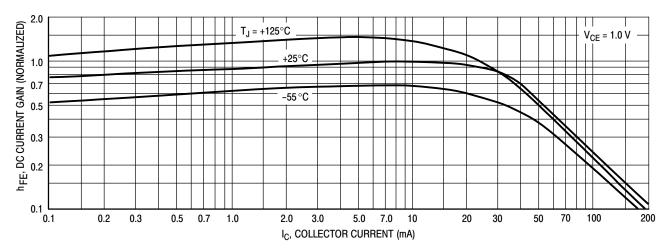
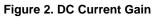


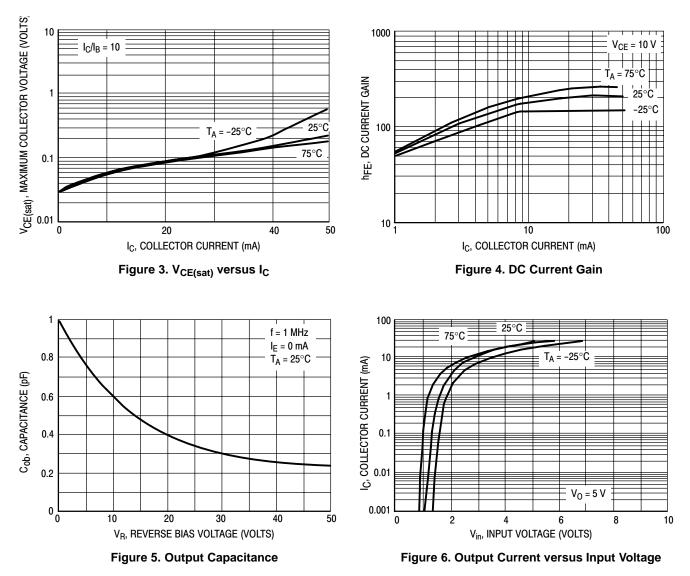
Figure 1. Derating Curve



TYPICAL ELECTRICAL CHARACTERISTICS - PNP TRANSISTOR



TYPICAL ELECTRICAL CHARACTERISTICS - NPN TRANSISTOR



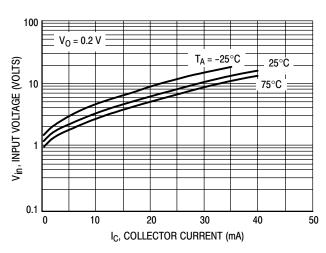
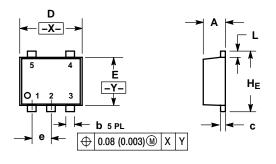


Figure 7. Input Voltage versus Output Current

PACKAGE DIMENSIONS

SOT-553 XV5 SUFFIX CASE 463B-01 ISSUE B

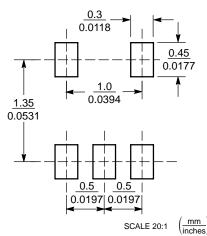


NOTES: 1. DIMENSIONING AND TOLERANCING PER

ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAI

	MILLIMETERS			INCHES				
DIM	MIN	NOM	MAX	MIN	NOM	MAX		
Α	0.50	0.55	0.60	0.020	0.022	0.024		
q	0.17	0.22	0.27	0.007	0.009	0.011		
С	0.08	0.13	0.18	0.003	0.005	0.007		
D	1.50	1.60	1.70	0.059	0.063	0.067		
Е	1.10	1.20	1.30	0.043	0.047	0.051		
e		0.50 BSC		0.020 BSC				
Г	0.10	0.20	0.30	0.004	0.008	0.012		
HE	1.50	1.60	1.70	0.059	0.063	0.067		

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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